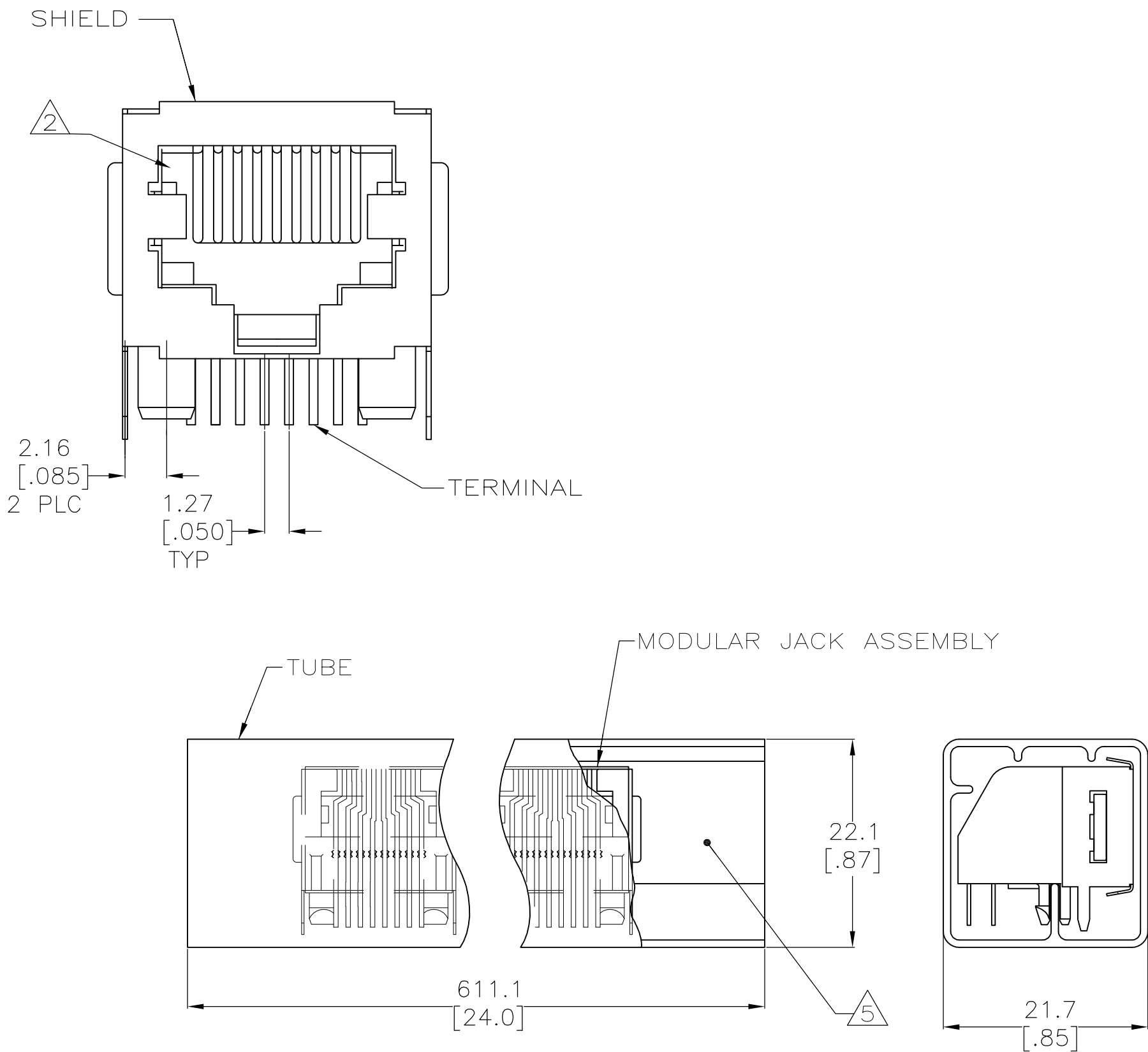
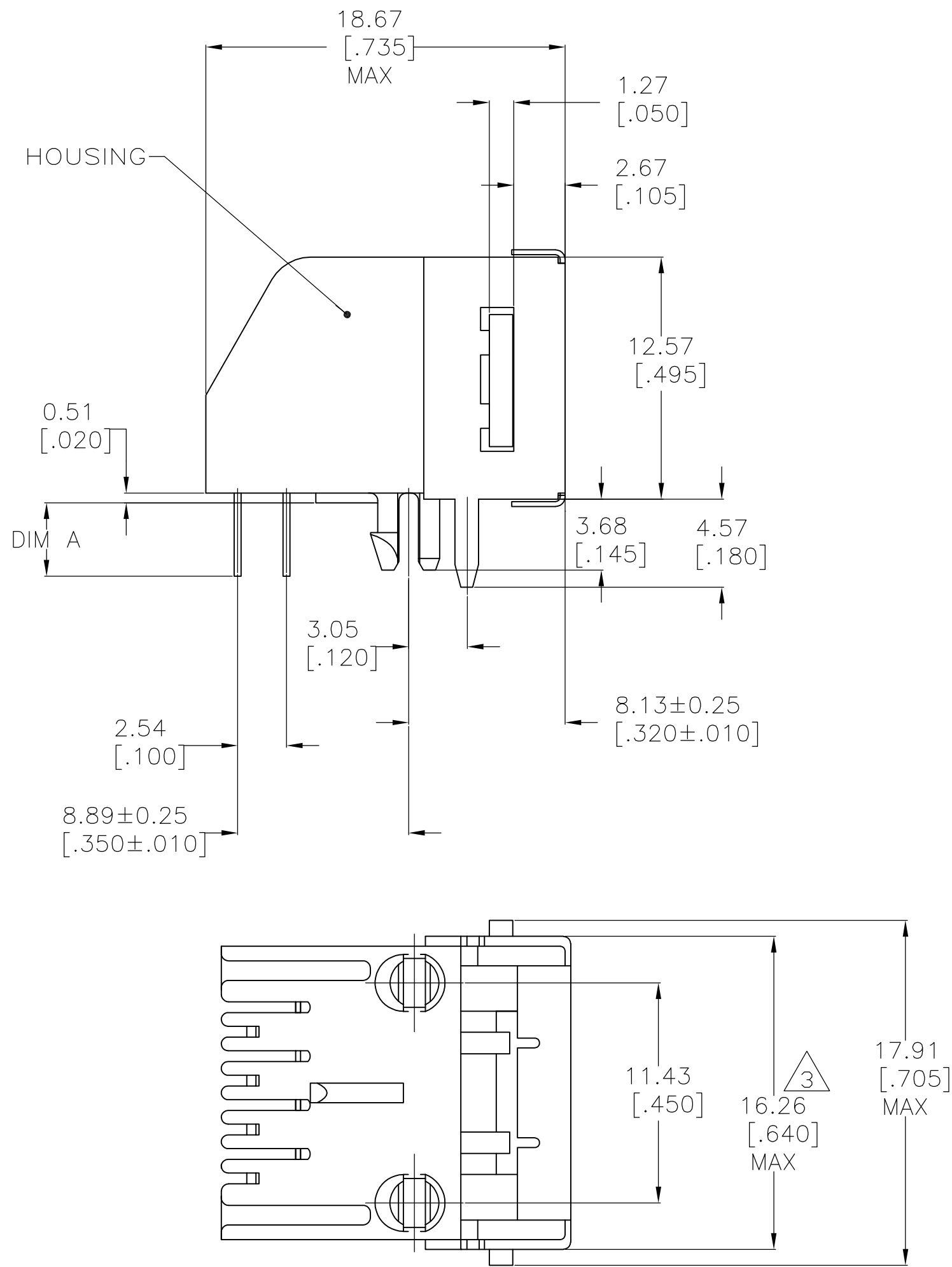


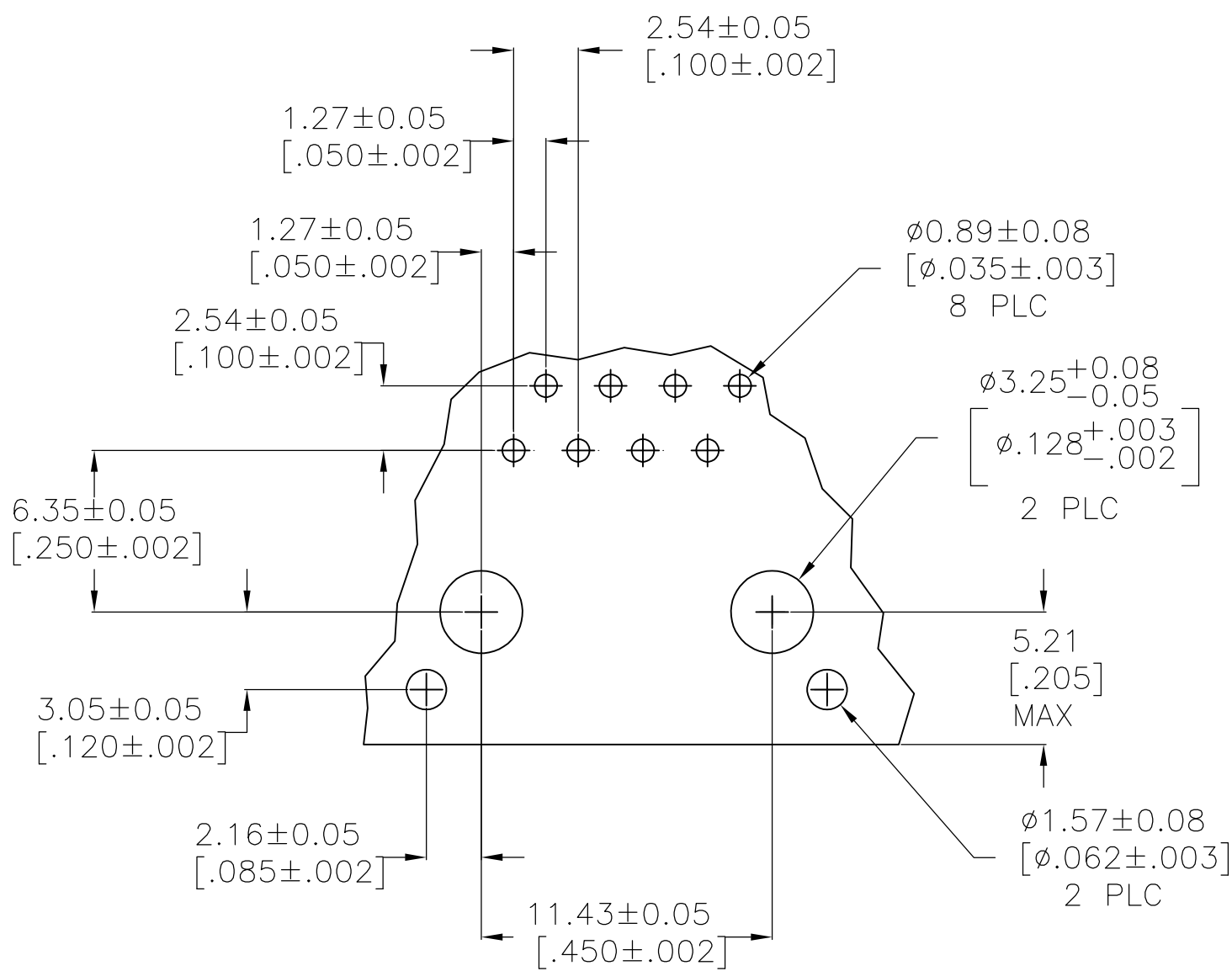
LOC	DIST	REVISIONS					
		REV	DATE	BY	CHK	APP	REV
GP	00	D1	REVISED PER ECO-11-005140	28MAR11	RK	HMR	

1. MATERIAL:  
HOUSING - PBT POLYESTER, COLOR: BLACK  
TERMINAL - 0.36[.014] THICK PHOS BRONZE PLATED WITH 1.27 $\mu$ m [.000050] THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND 2.03 $\mu$ m [.000080] THICK MATTE TIN IN SOLDER AREA OVER 1.27 $\mu$ m [.000050] THICK NICKEL UNDERPLATE  
SHIELD - 0.25 [.010] THICK COPPER ALLOY PLATED WITH 3.0 $\mu$ m [.000120] MINIMUM THICK REFLOWED TIN

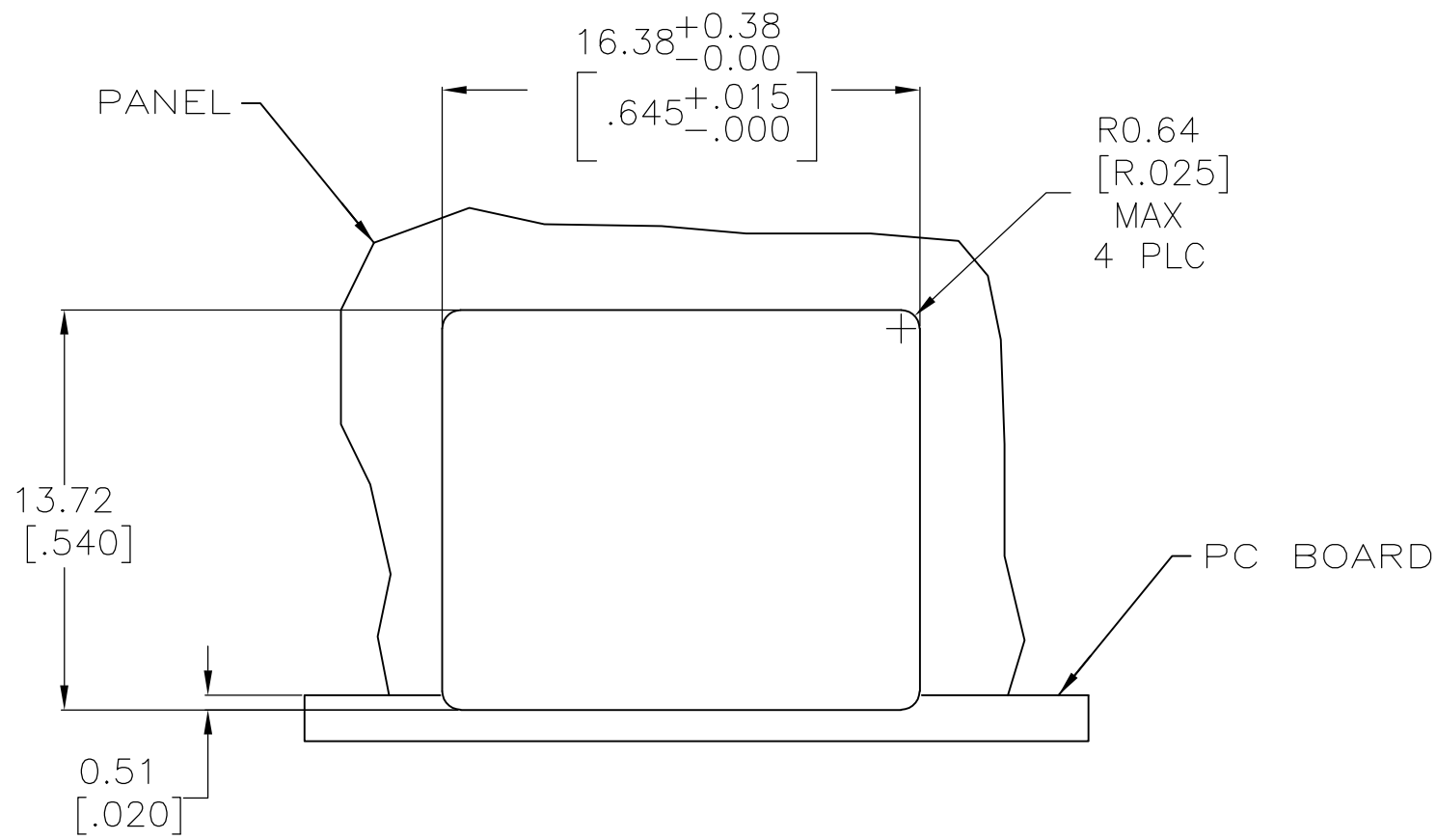
- 2 CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- 3 DIMENSIONS MEASURED ALONG FRONT EDGES OF MATING FACE
- 4 BULK PACKAGED IN A TRAY
- 5 32 ASSEMBLIES PACKAGED PER TUBE. SEE DETAIL B



DETAIL B  
SCALE 2:1


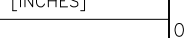


RECOMMENDED PRINTED CIRCUIT BOARD LAYOUT  
(COMPONENT SIDE)



RECOMMENDED PANEL CUTOUT

1.78-2.79[.09 $\pm$ .02]	4	5555153-6
2.54-3.05[.11 $\pm$ .01]	4	5555153-5
3.30-4.32[.15 $\pm$ .02]	5	5555153-3
3.30-4.32[.15 $\pm$ .02]	4	5555153-1
DIM A	PACKAGED	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN C. GARRETT/L.A. MAYER CHK P. RECCE APVD S. FLICKINGER	05NOV2007 05NOV2007 05NOV2007	 TE Connectivity			
DIMENSIONS: mm [INCHES]	TOLERANCES UNLESS OTHERWISE SPECIFIED:	NAME		MODULAR JACK ASSEMBLY,			
		PRODUCT SPEC		SHIELDED, 8 POSITION, LOW PROFILE, RIGHT ANGLE,			
	FINISH	APPLICATION SPEC		PANEL GROUND WITH PANEL STOPS			
		114-2048		SIZE	CAGE CODE	DRAWING NO	RESTRICTED TO
MATERIAL		WEIGHT		A1 00779 C=5555153		—	
SEE NOTE 1		CUSTOMER DRAWING		SCALE 4:1		SHEET 1 OF 1	REV D1